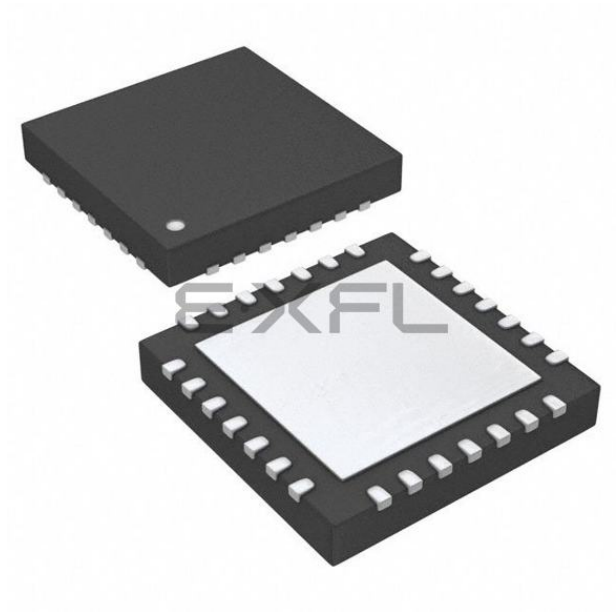

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	64MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.3V ~ 5.5V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	28-VQFN Exposed Pad
Supplier Device Package	28-QFN (6x6)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f25k40-e-ml

3.3 Code Protection

Code protection allows the device to be protected from unauthorized access. Program memory protection and data memory are controlled independently. Internal access to the program memory is unaffected by any code protection setting.

3.3.1 PROGRAM MEMORY PROTECTION

The entire program memory space is protected from external reads and writes by the $\overline{CP}$ bit in Configuration Words. When $\overline{CP}$ = 0, external reads and writes of program memory are inhibited and a read will return all '0's. The CPU can continue to read program memory, regardless of the protection bit settings. Self-writing the program memory is dependent upon the write protection setting. See **Section 3.4 "Write Protection"** for more information.

3.3.2 DATA MEMORY PROTECTION

The entire Data EEPROM Memory space is protected from external reads and writes by the $\overline{CPD}$ bit in the Configuration Words. When $\overline{CPD}$ = 0, external reads and writes of Data EEPROM Memory are inhibited and a read will return all '0's. The CPU can continue to read Data EEPROM Memory regardless of the protection bit settings.

3.4 Write Protection

Write protection allows the device to be protected from unintended self-writes. Applications, such as boot loader software, can be protected while allowing other regions of the program memory to be modified.

The WRT<1:0> bits in Configuration Words define the size of the program memory block that is protected.

3.5 User ID

Eight words in the memory space (200000h-200000Fh) are designated as ID locations where the user can store checksum or other code identification numbers. These locations are readable and writable during normal execution. See **Section 11.2 "User ID, Device ID and Configuration Word Access"** for more information on accessing these memory locations. For more information on checksum calculation, see the "PIC18(L)F2X/4XK40 Memory Programming Specification" (DS40001772).

4.2 Register Definitions: Oscillator Control

REGISTER 4-1: OSCCON1: OSCILLATOR CONTROL REGISTER1

U-0	R/W-f/f	R/W-f/f	R/W-f/f	R/W-q/q	R/W-q/q	R/W-q/q	R/W-q/q
—	NOSC<2:0>			NDIV<3:0>			
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	f = determined by fuse setting
		q = Reset value is determined by hardware

bit 7 **Unimplemented:** Read as ‘0’

bit 6-4 **NOSC<2:0>:** New Oscillator Source Request bits(1,2,3)
The setting requests a source oscillator and PLL combination per Table 4-2.
POR value = RSTOSC (Register 3-1).

bit 3-0 **NDIV<3:0>:** New Divider Selection Request bits(2,3)
The setting determines the new postscaler division ratio per Table 4-2.

Note 1: The default value (f/f) is determined by the RSTOSC Configuration bits. See Table 4-1below.
2: If NOSC is written with a reserved value (Table 4-2), the operation is ignored and neither NOSC nor NDIV is written.
3: When CSWEN = 0, this register is read-only and cannot be changed from the POR value.

TABLE 4-1: DEFAULT OSCILLATOR SETTINGS USING RSTOSC BITS

RSTOSC	SFR Reset Values			Initial FOSC Frequency
	NOSC/COSC	CDIV	OSCFRQ	
111	111	1:1	4 MHz	EXTOSC per FEXTOSC
110	110	4:1		FOSC = 1 MHz (4 MHz/4)
101	101	1:1		LFINTOSC
100	100	1:1		SOSC
011	Reserved			
010	010	1:1	4 MHz	EXTOSC + 4xPLL (1)
001	Reserved			
000	110	1:1	64 MHz	FOSC = 64 MHz

Note 1: EXTOSC must meet the PLL specifications (Table 37-9).

REGISTER 7-5: PMD4: PMD CONTROL REGISTER 4

U-0	R/W-0/0	U-0	R/W-0/0	U-0	U-0	U-0	R/W-0/0
—	UART1MD	—	MSSP1MD	—	—	—	CWG1MD
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	q = Value depends on condition

bit 7 **Unimplemented:** Read as ‘0’

bit 6 **UART1MD:** Disable EUSART1 bit
1 = EUSART1 module disabled
0 = EUSART1 module enabled

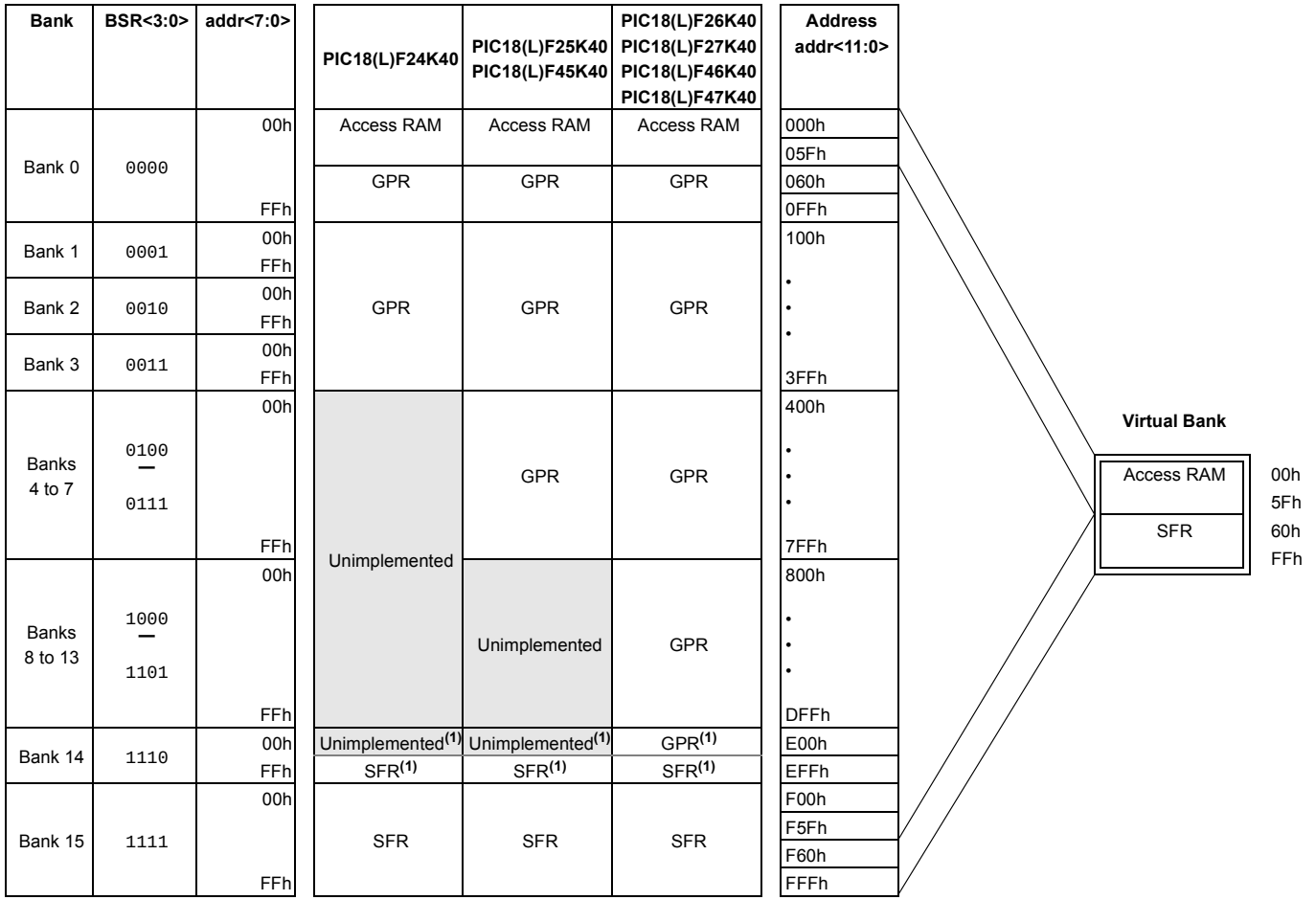
bit 5 **Unimplemented:** Read as ‘0’

bit 4 **MSSP1MD:** Disable MSSP1 bit
1 = MSSP1 module disabled
0 = MSSP1 module enabled

bit 3-1 **Unimplemented:** Read as ‘0’

bit 0 **CWG1MD:** Disable CWG1 Module bit
1 = CWG1 module disabled
0 = CWG1 module enabled

FIGURE 10-4: DATA MEMORY MAP FOR PIC18(L)F2X/4XK40 DEVICES



Note 1: It depends on the number of SFRs. Refer to Table 10-3 and Table 10-4.

10.4.2 ACCESS BANK

While the use of the BSR with an embedded 8-bit address allows users to address the entire range of data memory, it also means that the user must always ensure that the correct bank is selected. Otherwise, data may be read from or written to the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. Verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Block 15. The lower half is known as the “Access RAM” and is composed of GPRs. This upper half is also where the device’s SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 10-4).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the ‘a’ parameter in the instruction). When ‘a’ is equal to ‘1’, the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When ‘a’ is ‘0’, however, the instruction is forced to use the Access Bank address map; the current value of the BSR is ignored entirely.

Using this “forced” addressing allows the instruction to operate on a data address in a single cycle, without updating the BSR first. For 8-bit addresses of 60h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables. Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST Configuration bit = 1). This is discussed in more detail in **Section 10.7.3 “Mapping the Access Bank in Indexed Literal Offset Mode”**.

10.4.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM, which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upwards towards the bottom of the SFR area. GPRs are not initialized by a Power-on Reset and are unchanged on all other Resets.

10.4.4 SPECIAL FUNCTION REGISTERS

The Special Function Registers (SFRs) are registers used by the CPU and peripheral modules for controlling the desired operation of the device. These registers are implemented as static RAM. SFRs start at the top of data memory (FFFh) and extend downward to occupy the top portion of Bank 15 (F38h to FFFh). A list of these registers is given in Table 10-3 and Table 10-4.

The SFRs can be classified into two sets: those associated with the “core” device functionality (ALU, Resets and interrupts) and those related to the peripheral functions. The Reset and Interrupt registers are described in their respective chapters, while the ALU’s STATUS register is described later in this section. Registers related to the operation of a peripheral feature are described in the chapter for that peripheral.

The SFRs are typically distributed among the peripherals whose functions they control. Unused SFR locations are unimplemented and read as ‘0’s.

11.3.5 WRITE VERIFY

Depending on the application, good programming practice may dictate that the value written to the memory should be verified against the original value. This should be used in applications where excessive writes can stress bits near the specification limit.

EXAMPLE 11-5: DATA EEPROM READ

```
; Data Memory Address to read
              BCF NVMCON1, NVMREG0   ; Setup Data EEPROM Access
              BCF NVMCON1, NVMREG1   ; Setup Data EEPROM Access
              MOVF EE_ADDRL, W       ;
              MOVWF NVMADRL          ; Setup Address low byte
              MOVF EE_ADDRH, W       ;
              MOVWF NVMADRH          ; Setup Address high byte (if applicable)
              BSF NVMCON1, RD        ; Issue EE Read
              MOVF NVMDAT, W         ; W = EE_DATA
```

EXAMPLE 11-6: DATA EEPROM WRITE

```
; Data Memory Address to write
            BCF      NVMCON1, NVMREG0 ; Setup Data EEPROM access
            BCF      NVMCON1, NVMREG1 ; Setup Data EEPROM access
            MOVF     EE_ADDRL, W      ;
            MOVWF    NVMADRL          ; Setup Address low byte
            MOVF     EE_ADDRH, W      ;
            MOVWF    NVMADRH          ; Setup Address high byte (if applicable)
; Data Memory Value to write
            MOVF     EE_DATA, W       ;
            MOVWF    NVMDAT           ;
; Enable writes
            BSF      NVMCON1, WREN    ;
; Disable interrupts
            BCF      INTCON, GIE      ;
; Required unlock sequence
            MOVLW    55h              ;
            MOVWF    NVMCON2          ;
            MOVLW    AAh              ;
            MOVWF    NVMCON2          ;
; Set WR bit to begin write
            BSF      NVMCON1, WR      ;
; Wait for write to complete
            BTFSC    NVMCON1, WR
            BRA      $-2
; Enable INT
            BSF      INTCON, GIE      ;
; Disable writes
            BCF      NVMCON1, WREN    ;
```

11.4 Register Definitions: Nonvolatile Memory

REGISTER 11-1: NVMCON1: NONVOLATILE MEMORY CONTROL 1 REGISTER

R/W-0/0	R/W-0/0	U-0	R/S/HC-0/0	R/W/HS-x/q	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
NVMREG<1:0>		—	FREE	WRERR	WREN	WR	RD
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	HC = Bit is cleared by hardware
x = Bit is unknown	-n = Value at POR	S = Bit can be set by software, but not cleared
'0' = Bit is cleared	'1' = Bit is set	U = Unimplemented bit, read as '0'

bit 7-6 **NVMREG<1:0>:** NVM Region Selection bit
10 =Access PFM Locations
x1 = Access User IDs, Configuration Bits, Rev ID and Device ID
00 = Access Data EEPROM Memory Locations

bit 5 **Unimplemented:** Read as '0'

bit 4 **FREE:** Program Flash Memory Erase Enable bit(1)
1 = Performs an erase operation on the next WR command
0 = The next WR command performs a write operation

bit 3 **WRERR:** Write-Reset Error Flag bit(2,3,4)
1 = A write operation was interrupted by a Reset (hardware set),
or WR was written to 1'b1 when an invalid address is accessed (Table 10-1, Table 11-1)
or WR was written to 1'b1 when NVMREG<1:0> and address do not point to the same region
or WR was written to 1'b1 when a write-protected address is accessed (Table 10-2).
0 = All write operations have completed normally

bit 2 **WREN:** Program/Erase Enable bit
1 = Allows program/erase and refresh cycles
0 = Inhibits programming/erasing and user refresh of NVM

bit 1 **WR:** Write Control bit(5,6,7)
When NVMREG points to a Data EEPROM Memory location:
1 = Initiates an erase/program cycle at the corresponding Data EEPROM Memory location
When NVMREG points to a PFM location:
1 = Initiates the PFM write operation with data from the holding registers
0 = NVM program/erase operation is complete and inactive

bit 0 **RD:** Read Control bit(8)
1 = Initiates a read at address pointed by NVMREG and NVMADR, and loads data into NVMDAT
0 = NVM read operation is complete and inactive

Note 1: This can only be used with PFM.
2: This bit is set when WR = 1 and clears when the internal programming timer expires or the write is completed successfully.
3: Bit must be cleared by the user; hardware will not clear this bit.
4: Bit may be written to '1' by the user in order to implement test sequences.
5: This bit can only be set by following the unlock sequence of **Section 11.1.4 "NVM Unlock Sequence"**.
6: Operations are self-timed and the WR bit is cleared by hardware when complete.
7: Once a write operation is initiated, setting this bit to zero will have no effect.
8: The bit can only be set in software. The bit is cleared by hardware when the operation is complete.

13.0 CYCLIC REDUNDANCY CHECK (CRC) MODULE WITH MEMORY SCANNER

The Cyclic Redundancy Check (CRC) module provides a software-configurable hardware-implemented CRC checksum generator. This module includes the following features:

- Any standard CRC up to 16 bits can be used
- Configurable Polynomial
- Any seed value up to 16 bits can be used
- Standard and reversed bit order available
- Augmented zeros can be added automatically or by the user
- Memory scanner for fast CRC calculations on program memory user data
- Software loadable data registers for communication CRC's

13.1 CRC Module Overview

The CRC module provides a means for calculating a check value of program memory. The CRC module is coupled with a memory scanner for faster CRC calculations. The memory scanner can automatically provide data to the CRC module. The CRC module can also be operated by directly writing data to SFRs, without using a scanner.

REGISTER 14-9: PIR7: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 7

R/W-0/0	R/W-0/0	R/W-0/0	U-0	U-0	U-0	U-0	R/W-0/0
SCANIF	CRCIF	NVMIF	—	—	—	—	CWG1IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SCANIF:** SCAN Interrupt Flag bit
1 = SCAN interrupt has occurred (must be cleared in software)
0 = SCAN interrupt has not occurred or has not been started

bit 6 **CRCIF:** CRC Interrupt Flag bit
1 = CRC interrupt has occurred (must be cleared in software)
0 = CRC interrupt has not occurred or has not been started

bit 5 **NVMIF:** NVM Interrupt Flag bit
1 = NVM interrupt has occurred (must be cleared in software)
0 = NVM interrupt has not occurred or has not been started

bit 4-1 **Unimplemented:** Read as '0'

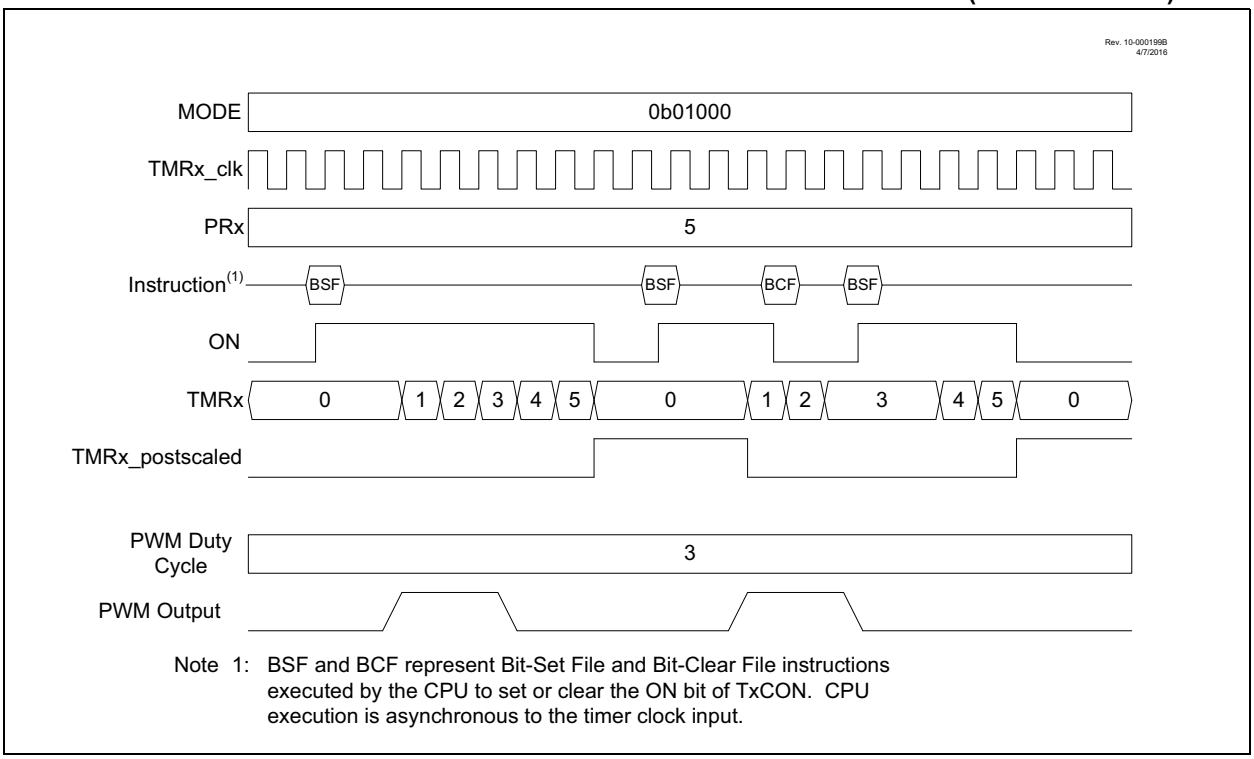
bit 0 **CWG1IF:** CWG Interrupt Flag bit
1 = CWG interrupt has occurred (must be cleared in software)
0 = CWG interrupt has not occurred or has not been started

20.5.5 SOFTWARE START ONE-SHOT MODE

In One-Shot mode the timer resets and the ON bit is cleared when the timer value matches the PRx period value. The ON bit must be set by software to start another timer cycle. Setting MODE<4:0> = 01000 selects One-Shot mode which is illustrated in Figure 20-8. In the example, ON is controlled by BSF and BCF instructions. In the first case, a BSF instruction sets ON and the counter runs to completion and clears ON. In the second case, a BSF instruction starts the cycle, BCF/BSF instructions turn the counter off and on during the cycle, and then it runs to completion.

When One-Shot mode is used in conjunction with the CCP PWM operation the PWM pulse drive starts concurrent with setting the ON bit. Clearing the ON bit while the PWM drive is active will extend the PWM drive. The PWM drive will terminate when the timer value matches the CCPRx pulse width value. The PWM drive will remain off until software sets the ON bit to start another cycle. If software clears the ON bit after the CCPRx match but before the PRx match then the PWM drive will be extended by the length of time the ON bit remains cleared. Another timing cycle can only be initiated by setting the ON bit after it has been cleared by a PRx period count match.

FIGURE 20-8: SOFTWARE START ONE-SHOT MODE TIMING DIAGRAM (MODE = 01000)



Note 1: BSF and BCF represent Bit-Set File and Bit-Clear File instructions executed by the CPU to set or clear the ON bit of TxCON. CPU execution is asynchronous to the timer clock input.

REGISTER 21-2: CCPTMRS: CCP TIMERS CONTROL REGISTER

R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1	R/W-0/0	R/W-1/1
P4TSEL<1:0>		P3TSEL<1:0>		C2TSEL<1:0>		C1TSEL<1:0>	
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **P4TSEL<1:0>:** PWM4 Timer Selection bits
11 = PWM4 based on TMR6
10 = PWM4 based on TMR4
01 = PWM4 based on TMR2
00 = Reserved

bit 5-4 **P3TSEL<1:0>:** PWM3 Timer Selection bits
11 = PWM3 based on TMR6
10 = PWM3 based on TMR4
01 = PWM3 based on TMR2
00 = Reserved

bit 3-2 **C2TSEL<1:0>:** CCP2 Timer Selection bits
11 = CCP2 is based off Timer5 in Capture/Compare mode and Timer6 in PWM mode
10 = CCP2 is based off Timer3 in Capture/Compare mode and Timer4 in PWM mode
01 = CCP2 is based off Timer1 in Capture/Compare mode and Timer2 in PWM mode
00 = Reserved

bit 1-0 **C1TSEL<1:0>:** CCP1 Timer Selection bits
11 = CCP1 is based off Timer5 in Capture/Compare mode and Timer6 in PWM mode
10 = CCP1 is based off Timer3 in Capture/Compare mode and Timer4 in PWM mode
01 = CCP1 is based off Timer1 in Capture/Compare mode and Timer2 in PWM mode
00 = Reserved

22.1.9 SETUP FOR PWM OPERATION USING PWMx PINS

The following steps should be taken when configuring the module for PWM operation using the PWMx pins:

1. Disable the PWMx pin output driver(s) by setting the associated TRIS bit(s).
2. Clear the PWMxCON register.
3. Load the PR2 register with the PWM period value.
4. Load the PWMxDCH register and bits <7:6> of the PWMxDCL register with the PWM duty cycle value.
5. Configure and start Timer2:
   - Clear the TMR2IF interrupt flag bit of the PIR4 register. See Note 1 below.
   - Select the timer clock source to be as FOSC/4 using the TxCLKCON register. This is required for correct operation of the PWM module.
   - Configure the T2CKPS bits of the T2CON register with the Timer2 prescale value.
   - Enable Timer2 by setting the T2ON bit of the T2CON register.
6. Enable PWM output pin and wait until Timer2 overflows, TMR2IF bit of the PIR4 register is set. See note below.
7. Enable the PWMx pin output driver(s) by clearing the associated TRIS bit(s) and setting the desired pin PPS control bits.
8. Configure the PWM module by loading the PWMxCON register with the appropriate values.

Note 1: In order to send a complete duty cycle and period on the first PWM output, the above steps must be followed in the order given. If it is not critical to start with a complete PWM signal, then move Step 8 to replace Step 4.

2: For operation with other peripherals only, disable PWMx pin outputs.

22.1.10 SETUP FOR PWM OPERATION TO OTHER DEVICE PERIPHERALS

The following steps should be taken when configuring the module for PWM operation to be used by other device peripherals:

1. Disable the PWMx pin output driver(s) by setting the associated TRIS bit(s).
2. Clear the PWMxCON register.
3. Load the PR2 register with the PWM period value.
4. Load the PWMxDCH register and bits <7:6> of the PWMxDCL register with the PWM duty cycle value.
5. Configure and start Timer2:
   - Clear the TMR2IF interrupt flag bit of the PIR4 register. See Note 1 below.
   - Select the timer clock source to be as FOSC/4 using the TxCLKCON register. This is required for correct operation of the PWM module.
   - Configure the T2CKPS bits of the T2CON register with the Timer2 prescale value.
   - Enable Timer2 by setting the T2ON bit of the T2CON register.
6. Enable PWM output pin:
   - Wait until Timer2 overflows, TMR2IF bit of the PIR4 register is set. See Note 1 below.
7. Configure the PWM module by loading the PWMxCON register with the appropriate values.

Note 1: In order to send a complete duty cycle and period on the first PWM output, the above steps must be included in the setup sequence. If it is not critical to start with a complete PWM signal on the first output, then step 6 may be ignored.

23.10 Register Definitions: ZCD Control

REGISTER 23-1: ZCDCON: ZERO-CROSS DETECT CONTROL REGISTER

R/W-0/0	U-0	R-x	R/W-0/0	U-0	U-0	R/W-0/0	R/W-0/0
ZCDSEN	—	ZCDOUT	ZCDPOL	—	—	ZCDINTP	ZCDINTN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ZCDSEN:** Zero-Cross Detect Software Enable bit
This bit is ignored when ZCDSEN fuse is set.
1= Zero-cross detect is enabled. ZCD pin is forced to output to source and sink current.
0= Zero-cross detect is disabled. ZCD pin operates according to PPS and TRIS controls.

bit 6 **Unimplemented:** Read as '0'

bit 5 **ZCDOUT:** Zero-Cross Detect Data Output bit
ZCDPOL bit = 0:
1 = ZCD pin is sinking current
0 = ZCD pin is sourcing current
ZCDPOL bit = 1:
1 = ZCD pin is sourcing current
0 = ZCD pin is sinking current

bit 4 **ZCDPOL:** Zero-Cross Detect Polarity bit
1 = ZCD logic output is inverted
0 = ZCD logic output is not inverted

bit 3-2 **Unimplemented:** Read as '0'

bit 1 **ZCDINTP:** Zero-Cross Detect Positive-Going Edge Interrupt Enable bit
1 = ZCDIF bit is set on low-to-high ZCD_output transition
0 = ZCDIF bit is unaffected by low-to-high ZCD_output transition

bit 0 **ZCDINTN:** Zero-Cross Detect Negative-Going Edge Interrupt Enable bit
1 = ZCDIF bit is set on high-to-low ZCD_output transition
0 = ZCDIF bit is unaffected by high-to-low ZCD_output transition

26.5.5 SPI OPERATION IN SLEEP MODE

In SPI Master mode, module clocks may be operating at a different speed than when in Full-Power mode; in the case of the Sleep mode, all clocks are halted.

Special care must be taken by the user when the MSSP clock is much faster than the system clock.

In Slave mode, when MSSP interrupts are enabled, after the master completes sending data, an MSSP interrupt will wake the controller from Sleep.

If an exit from Sleep mode is not desired, MSSP interrupts should be disabled.

In SPI Master mode, when the Sleep mode is selected, all module clocks are halted and the transmission/reception will remain in that state until the device wakes. After the device returns to Run mode, the module will resume transmitting and receiving data.

In SPI Slave mode, the SPI Transmit/Receive Shift register operates asynchronously to the device. This allows the device to be placed in Sleep mode and data to be shifted into the SPI Transmit/Receive Shift register. When all eight bits have been received, the MSSP interrupt flag bit will be set and if enabled, will wake the device.

TABLE 26-1: SUMMARY OF REGISTERS ASSOCIATED WITH SPI OPERATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
INTCON	GIE/GIEH	PEIE/GIEL	IPEN	—	—	INT2EDG	INT1EDG	INT0EDG	166
PIE3	—	—	RC1IE	TX1IE	—	—	BCL1IE	SSP1IE	178
PIR3	—	—	RC1IF	TX1IF	—	—	BCL1IF	SSP1IF	170
IPR3	—	—	RC1IP	TX1IP	—	—	BCL1IP	SSP1IP	186
RxyPPS	—	—	—	RxyPPS<4:0>					213
SSPxBUF	BUF<7:0>								330*
SSPxCLKPPS	—	—	—	SSPxCLKPPS<4:0>					211
SSPxCON1	WCOL	SSPOV	SSPEN	CKP	SSPM<3:0>				332
SSPxCON3	ACKTIM	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN	333
SSPxDATPPS	—	—	—	SSPDATPPS<4:0>					211
SSPxSSPPS	—	—	—	SSPSSPPS<4:0>					211
SSPxSTAT	SMP	CKE	D/$\overline{A}$	P	S	R/$\overline{W}$	UA	BF	347

Legend: — = Unimplemented location, read as '0'. Shaded cells are not used by the MSSP in SPI mode.

* Page provides register information.

26.9.4 SLAVE MODE 10-BIT ADDRESS RECEPTION

This section describes a standard sequence of events for the MSSP module configured as an I^2C slave in 10-bit Addressing mode.

Figure 26-20 is used as a visual reference for this description.

This is a step by step process of what must be done by slave software to accomplish I^2C communication.

1. Bus starts Idle.
2. Master sends Start condition; S bit of SSPxSTAT is set; SSPxIF is set if interrupt on Start detect is enabled.
3. Master sends matching high address with R/$\overline{W}$ bit clear; UA bit of the SSPxSTAT register is set.
4. Slave sends $\overline{ACK}$ and SSPxIF is set.
5. Software clears the SSPxIF bit.
6. Software reads received address from SSPxBUF clearing the BF flag.
7. Slave loads low address into SSPxADD, releasing SCL.
8. Master sends matching low address byte to the slave; UA bit is set.

Note: Updates to the SSPxADD register are not allowed until after the $\overline{ACK}$ sequence.

9. Slave sends $\overline{ACK}$ and SSPxIF is set.

Note: If the low address does not match, SSPxIF and UA are still set so that the slave software can set SSPxADD back to the high address. BF is not set because there is no match. CKP is unaffected.

10. Slave clears SSPxIF.
11. Slave reads the received matching address from SSPxBUF clearing BF.
12. Slave loads high address into SSPxADD.
13. Master clocks a data byte to the slave and clocks out the slaves $\overline{ACK}$ on the ninth SCL pulse; SSPxIF is set.
14. If SEN bit of SSPxCON2 is set, CKP is cleared by hardware and the clock is stretched.
15. Slave clears SSPxIF.
16. Slave reads the received byte from SSPxBUF clearing BF.
17. If SEN is set the slave sets CKP to release the SCL.
18. Steps 13-17 repeat for each received byte.
19. Master sends Stop to end the transmission.

26.9.5 10-BIT ADDRESSING WITH ADDRESS OR DATA HOLD

Reception using 10-bit addressing with AHEN or DHEN set is the same as with 7-bit modes. The only difference is the need to update the SSPxADD register using the UA bit. All functionality, specifically when the CKP bit is cleared and SCL line is held low are the same. Figure 26-21 can be used as a reference of a slave in 10-bit addressing with AHEN set.

Figure 26-22 shows a standard waveform for a slave transmitter in 10-bit Addressing mode.

TABLE 27-2: SUMMARY OF REGISTERS ASSOCIATED WITH ASYNCHRONOUS RECEPTION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
BAUDxCON	ABDOVF	RCIDL	—	SCKP	BRG16	—	WUE	ABDEN	389
INTCON	GIE/GIEH	PEIE/GIEL	IPEN	—	—	INT2EDG	INT1EDG	INT0EDG	166
PIE3	—	—	RC1IE	TX1IE	—	—	BCL1IE	SSP1IE	178
PIR3	—	—	RC1IF	TX1IF	—	—	BCL1IF	SSP1IF	170
IPR3	—	—	RC1IP	TX1IP	—	—	BCL1IP	SSP1IP	186
RCxREG	EUSARTx Receive Register								393*
RCxSTA	SPEN	RX9	SREN	CREN	ADDEN	FERR	OERR	RX9D	388
RxyPPS	—	—	—	RxyPPS<4:0>					213
RXxPPS	—	—	—	RXPPS<4:0>					211
SPxBRGH	EUSARTx Baud Rate Generator, High Byte								398*
SPxBRGL	EUSARTx Baud Rate Generator, Low Byte								398*
TXxSTA	CSRC	TX9	TXEN	SYNC	SENDB	BRGH	TRMT	TX9D	387

Legend: — = unimplemented location, read as '0'. Shaded cells are not used for asynchronous reception.
* Page provides register information.

FIGURE 27-7: AUTO-WAKE-UP BIT (WUE) TIMING DURING NORMAL OPERATION

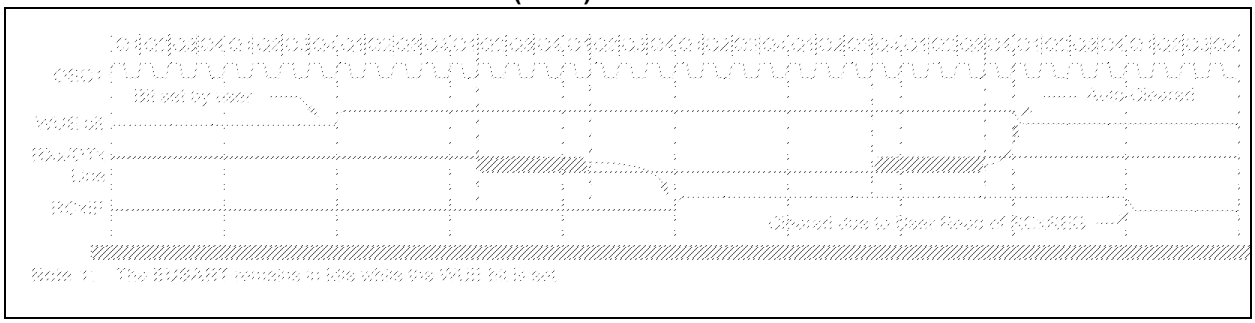


FIGURE 27-8: AUTO-WAKE-UP BIT (WUE) TIMINGS DURING SLEEP

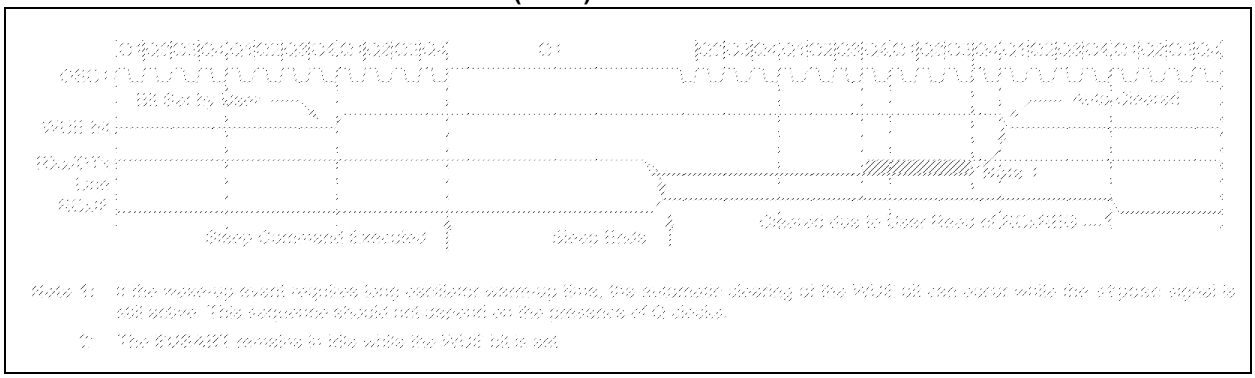


TABLE 37-11: RESET, WDT, OSCILLATOR START-UP TIMER, POWER-UP TIMER, BROWN-OUT RESET AND LOW-POWER BROWN-OUT RESET SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated)							
Param No.	Sym.	Characteristic	Min.	Typ†	Max.	Units	Conditions
RST01*	TMCLR	$\overline{MCLR}$ Pulse Width Low to ensure Reset	2	—	—	µs	
RST02*	TIOZ	I/O high-impedance from Reset detection	—	—	2	µs	
RST03	TWDT	Watchdog Timer Time-out Period	—	16	—	ms	1:512 Prescaler
RST04*	TPWRT	Power-up Timer Period	—	65	—	ms	
RST05	TOST	Oscillator Start-up Timer Period(1,2)	—	1024	—	TOSC	
RST06	VBOR	Brown-out Reset Voltage(4)	2.7 2.55 2.3 2.3 1.8	2.85 2.7 2.45 2.45 1.9	3.0 2.85 2.6 2.6 2.1	V V V V V	BORV = 00 BORV = 01 BORV = 10 BORV = 11 (PIC18Fxxx) BORV = 11 (PIC18LFxxx)
RST07	VBORHYS	Brown-out Reset Hysteresis	—	40	—	mV	
RST08	TBORDC	Brown-out Reset Response Time	—	3	—	µs	
RST09	VLPBOR	Low-Power Brown-out Reset Voltage	1.8	1.9	2.5	V	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

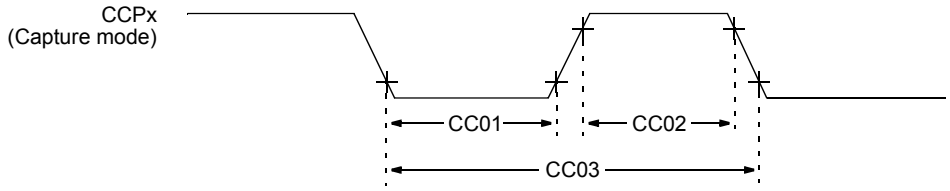
Note 1: By design, the Oscillator Start-up Timer (OST) counts the first 1024 cycles, independent of frequency.

2: To ensure these voltage tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

TABLE 37-12: HIGH/LOW-VOLTAGE DETECT CHARACTERISTICS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	Symbol	Characteristic	Min.	Typ†	Max.	Units	Conditions
HLVD01	V_{DET}	Voltage Detection	—	1.90	—	V	HLVDSEL<3:0>=0000
			—	2.10	—	V	HLVDSEL<3:0>=0001
			—	2.25	—	V	HLVDSEL<3:0>=0010
			—	2.50	—	V	HLVDSEL<3:0>=0011
			—	2.60	—	V	HLVDSEL<3:0>=0100
			—	2.75	—	V	HLVDSEL<3:0>=0101
			—	2.90	—	V	HLVDSEL<3:0>=0110
			—	3.15	—	V	HLVDSEL<3:0>=0111
			—	3.35	—	V	HLVDSEL<3:0>=1000
			—	3.60	—	V	HLVDSEL<3:0>=1001
			—	3.75	—	V	HLVDSEL<3:0>=1010
			—	4.00	—	V	HLVDSEL<3:0>=1011
			—	4.20	—	V	HLVDSEL<3:0>=1100
			—	4.35	—	V	HLVDSEL<3:0>=1101
			—	4.65	—	V	HLVDSEL<3:0>=1110

FIGURE 37-13: CAPTURE/COMPARE/PWM TIMINGS (CCP)



Note: Refer to Figure 37-4 for load conditions.

TABLE 37-20: CAPTURE/COMPARE/PWM REQUIREMENTS (CCP)

Standard Operating Conditions (unless otherwise stated) Operating Temperature -40°C ≤ TA ≤ +125°C								
Param No.	**Sym.**	**Characteristic**		**Min.**	**Typ†**	**Max.**	**Units**	**Conditions**
CC01*	TccL	CCPx Input Low Time	No Prescaler	0.5TCY + 20	—	—	ns	
			With Prescaler	20	—	—	ns	
CC02*	TccH	CCPx Input High Time	No Prescaler	0.5TCY + 20	—	—	ns	
			With Prescaler	20	—	—	ns	
CC03*	TccP	CCPx Input Period		$\frac{3T_{CY} + 40}{N}$	—	—	ns	N = prescale value

* These parameters are characterized but not tested.

† Data in "Typ" column is at 3.0V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

TABLE 37-25: I²C BUS DATA REQUIREMENTS

Standard Operating Conditions (unless otherwise stated)							
Param. No.	**Symbol**	**Characteristic**		**Min.**	**Max.**	**Units**	**Conditions**
SP100*	THIGH	Clock high time	100 kHz mode	4.0	—	μs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	0.6	—	μs	Device must operate at a minimum of 10 MHz
			SSP module	1.5TCY	—		
SP101*	TLOW	Clock low time	100 kHz mode	4.7	—	μs	Device must operate at a minimum of 1.5 MHz
			400 kHz mode	1.3	—	μs	Device must operate at a minimum of 10 MHz
			SSP module	1.5TCY	—		
SP102*	TR	SDA and SCL rise time	100 kHz mode	—	1000	ns	
			400 kHz mode	20 + 0.1CB	300	ns	CB is specified to be from 10-400 pF
SP103*	TF	SDA and SCL fall time	100 kHz mode	—	250	ns	
			400 kHz mode	20 + 0.1CB	250	ns	CB is specified to be from 10-400 pF
SP106*	THD:DAT	Data input hold time	100 kHz mode	0	—	ns	
			400 kHz mode	0	0.9	μs	
SP107*	TSU:DAT	Data input setup time	100 kHz mode	250	—	ns	**(Note 2)**
			400 kHz mode	100	—	ns	
SP109*	TAA	Output valid from clock	100 kHz mode	—	3500	ns	**(Note 1)**
			400 kHz mode	—	—	ns	
SP110*	TBUF	Bus free time	100 kHz mode	4.7	—	μs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	μs	
SP111	CB	Bus capacitive loading		—	400	pF	

* These parameters are characterized but not tested.

Note 1: As a transmitter, the device must provide this internal minimum delay time to bridge the undefined region (min. 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.

2: A Fast mode (400 kHz) I²C bus device can be used in a Standard mode (100 kHz) I²C bus system, but the requirement TSU:DAT ≥ 250 ns must then be met. This will automatically be the case if the device does not stretch the low period of the SCL signal. If such a device does stretch the low period of the SCL signal, it must output the next data bit to the SDA line TR max. + TSU:DAT = 1000 + 250 = 1250 ns (according to the Standard mode I²C bus specification), before the SCL line is released.